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(12) **United States Design Patent**
Lowes et al.

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(54) **LED PACKAGE**

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(**) Term: **14 Years**

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(51) **LOC (10) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/180**

(58) **Field of Classification Search**
USPC D13/180; D26/1; 257/79, 80, 81, 88,
257/89, 95, 98, 99, 100, E33.058; 313/483,
313/498, 500; 362/555, 800
See application file for complete search history.

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(57) **CLAIM**

The ornamental design for an LED package, as shown and described herein.

DESCRIPTION

FIG. 1 is a top perspective view of an LED package according to one embodiment of the present invention.

FIG. 2 is a bottom perspective view of the LED package shown in FIG. 1.

FIG. 3 is a right elevation view of the LED package shown in FIG. 1.

FIG. 4 is a left elevation view of the LED package shown in FIG. 1.

FIG. 5 is a top view of the LED package shown in FIG. 1.

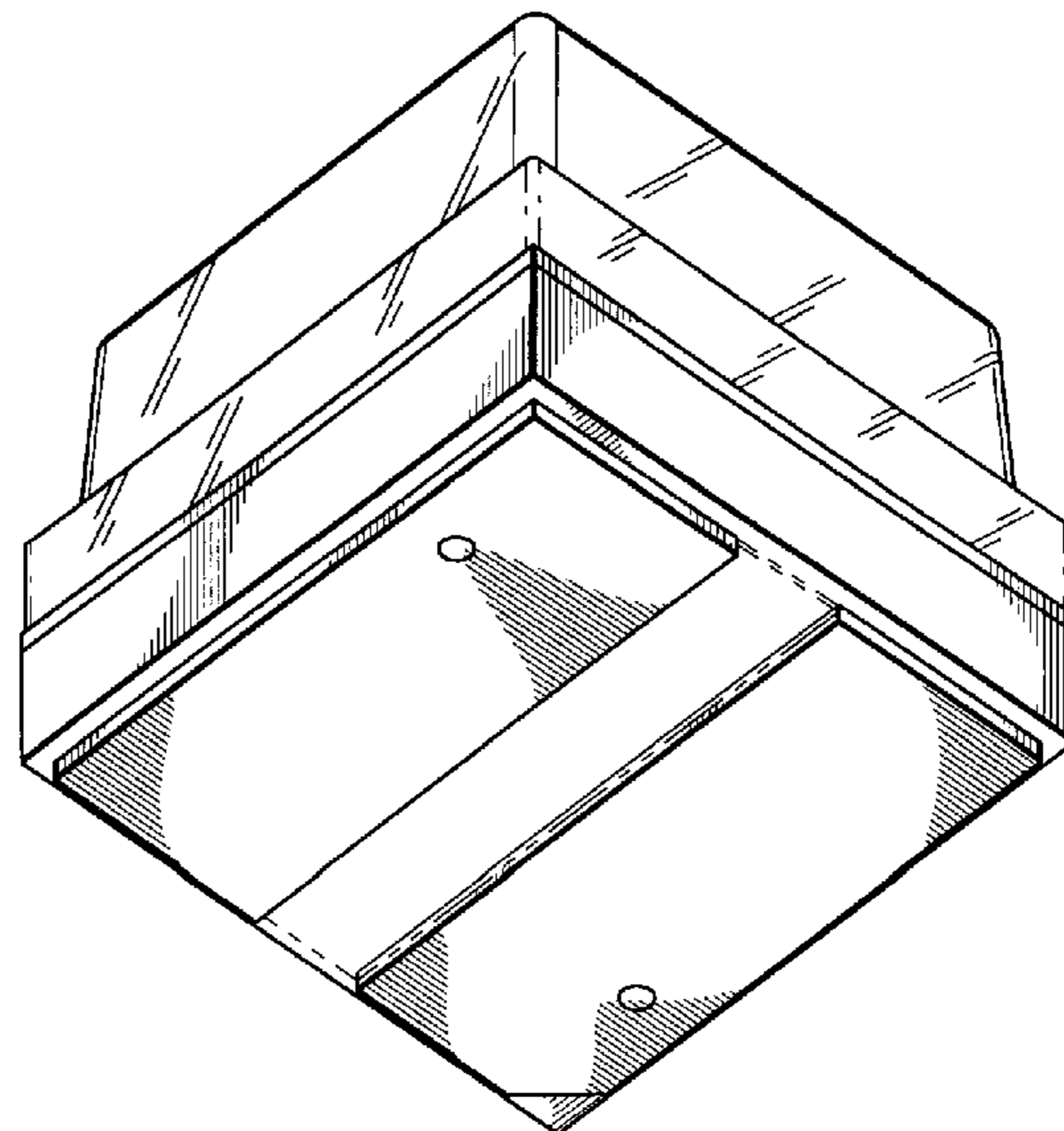
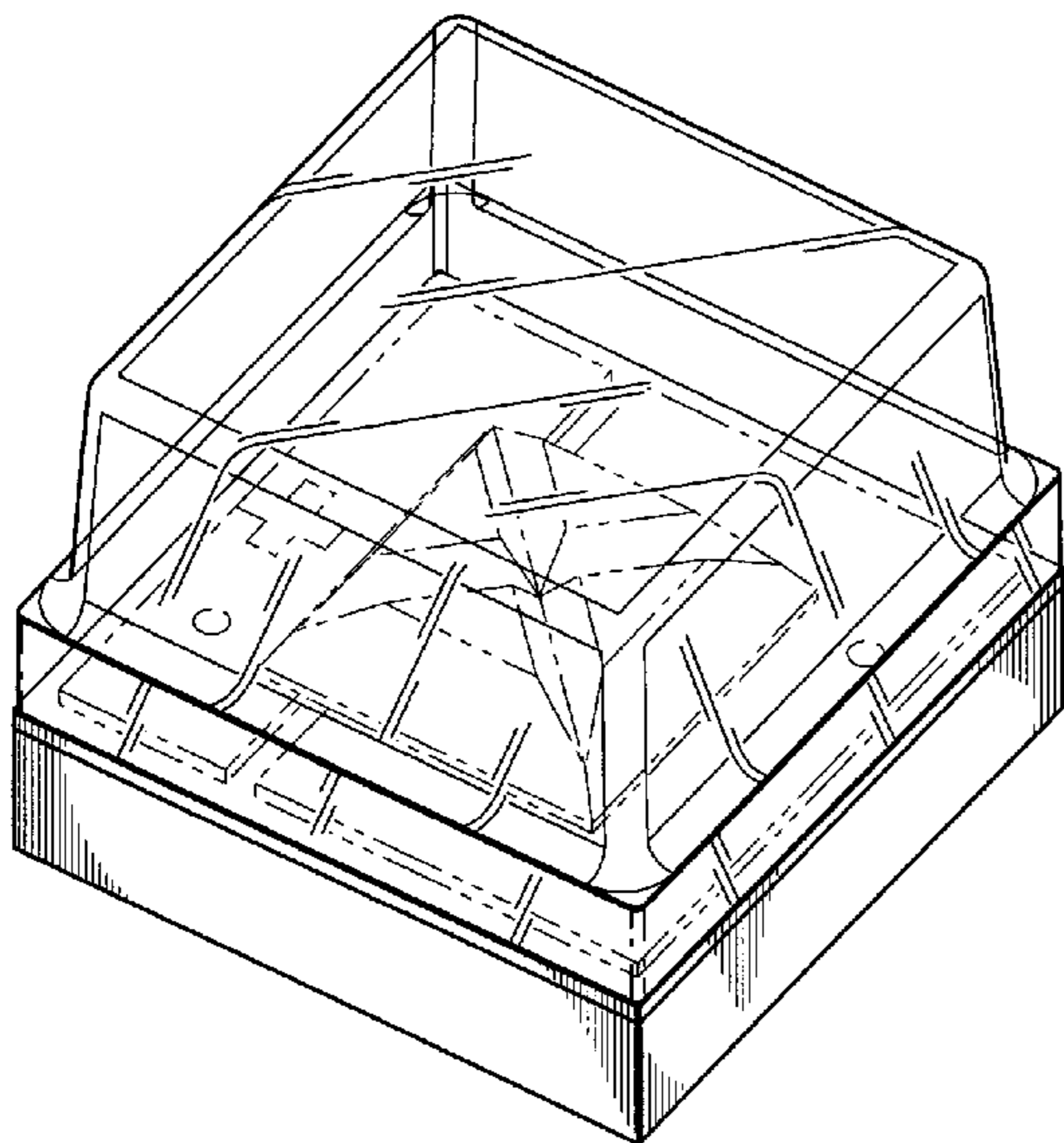
FIG. 6 is a bottom view of the LED package shown in FIG. 1.

FIG. 7 is a front elevation view of the LED package shown in FIG. 1; and,

FIG. 8 is a back elevation view of the LED package shown in FIG. 1.

The broken lines shown in the above figures depict environmental subject matter only and form no part of the claimed design in those embodiments.

1 Claim, 3 Drawing Sheets



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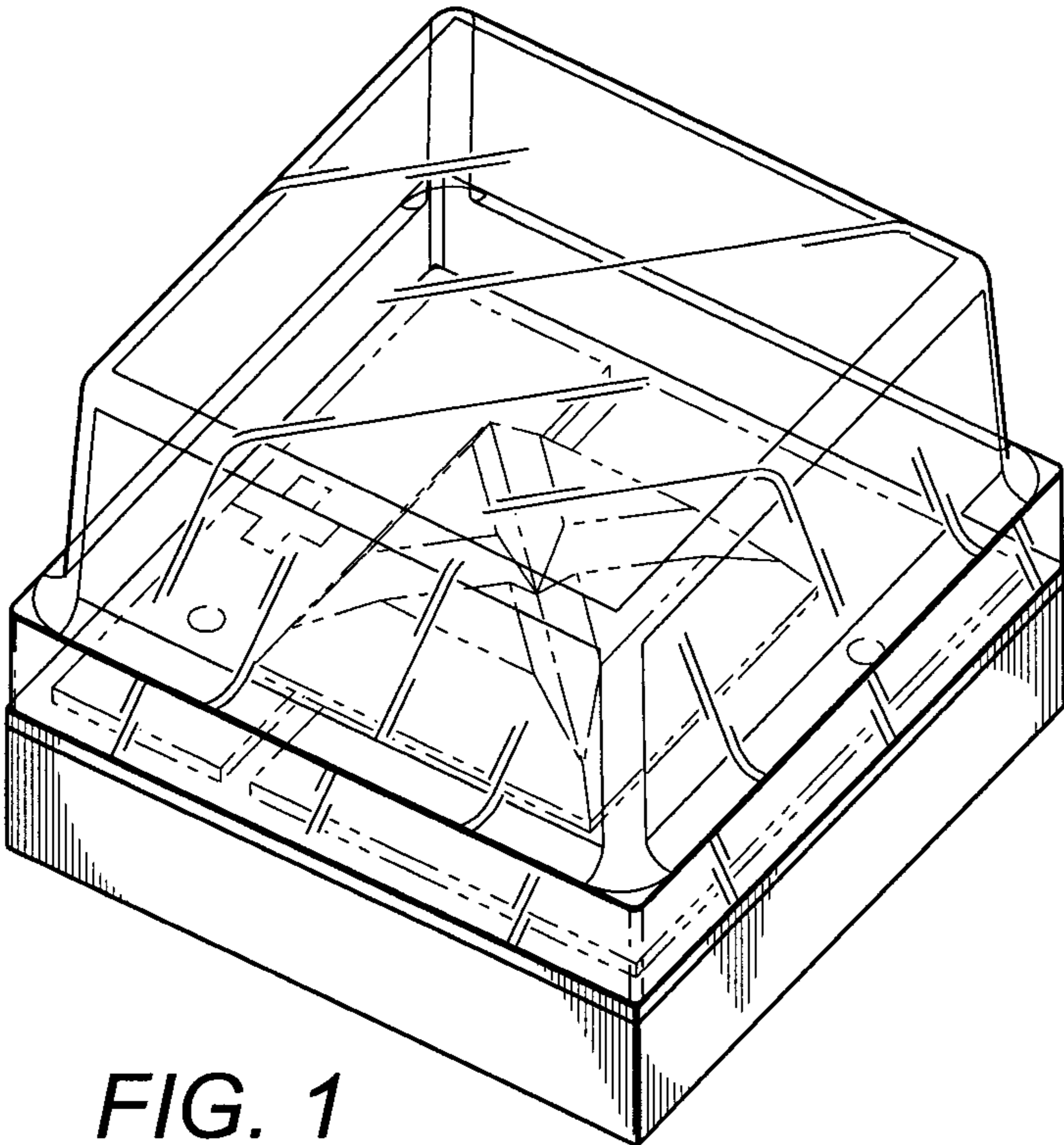


FIG. 1

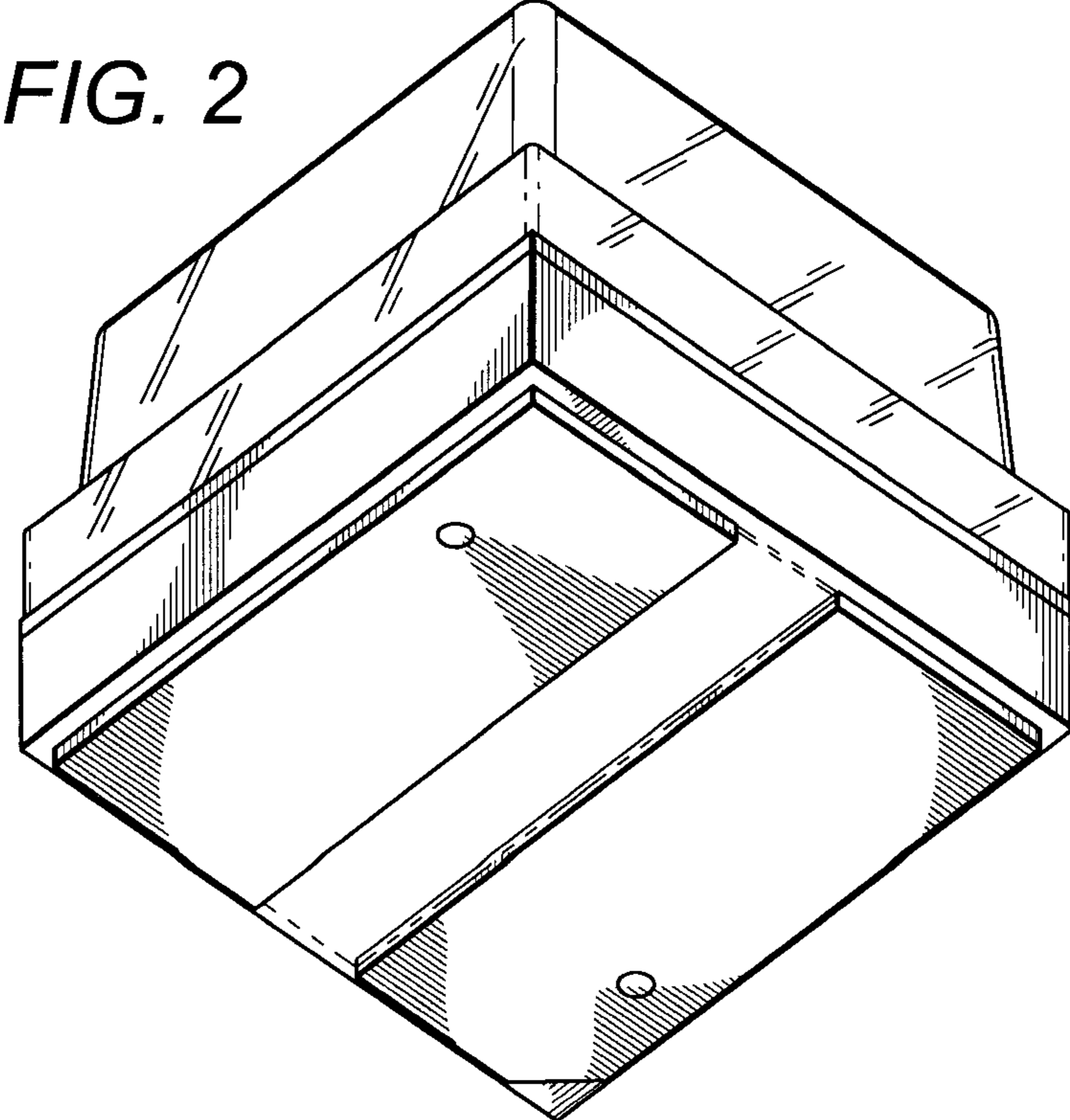


FIG. 2

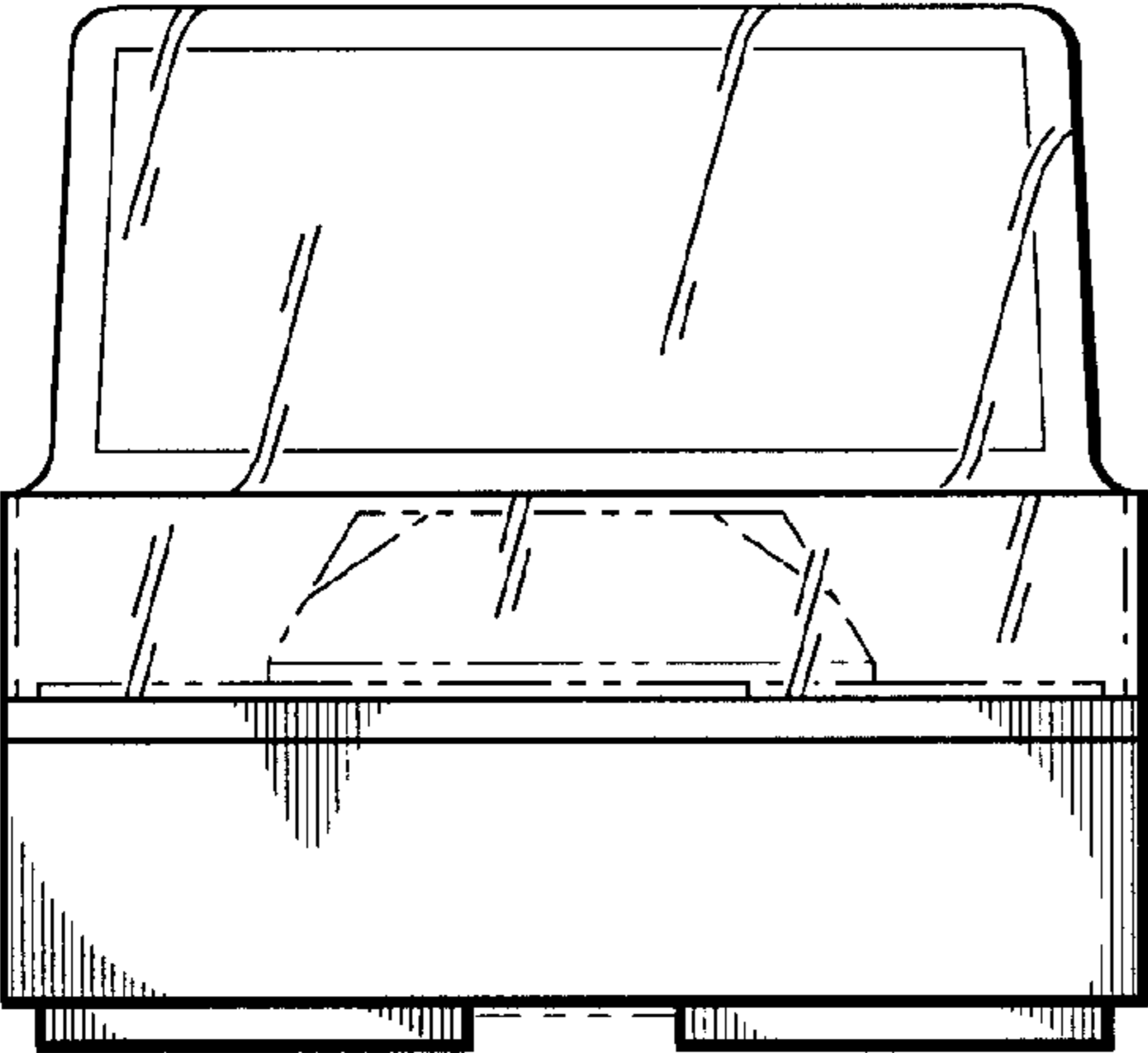


FIG. 3

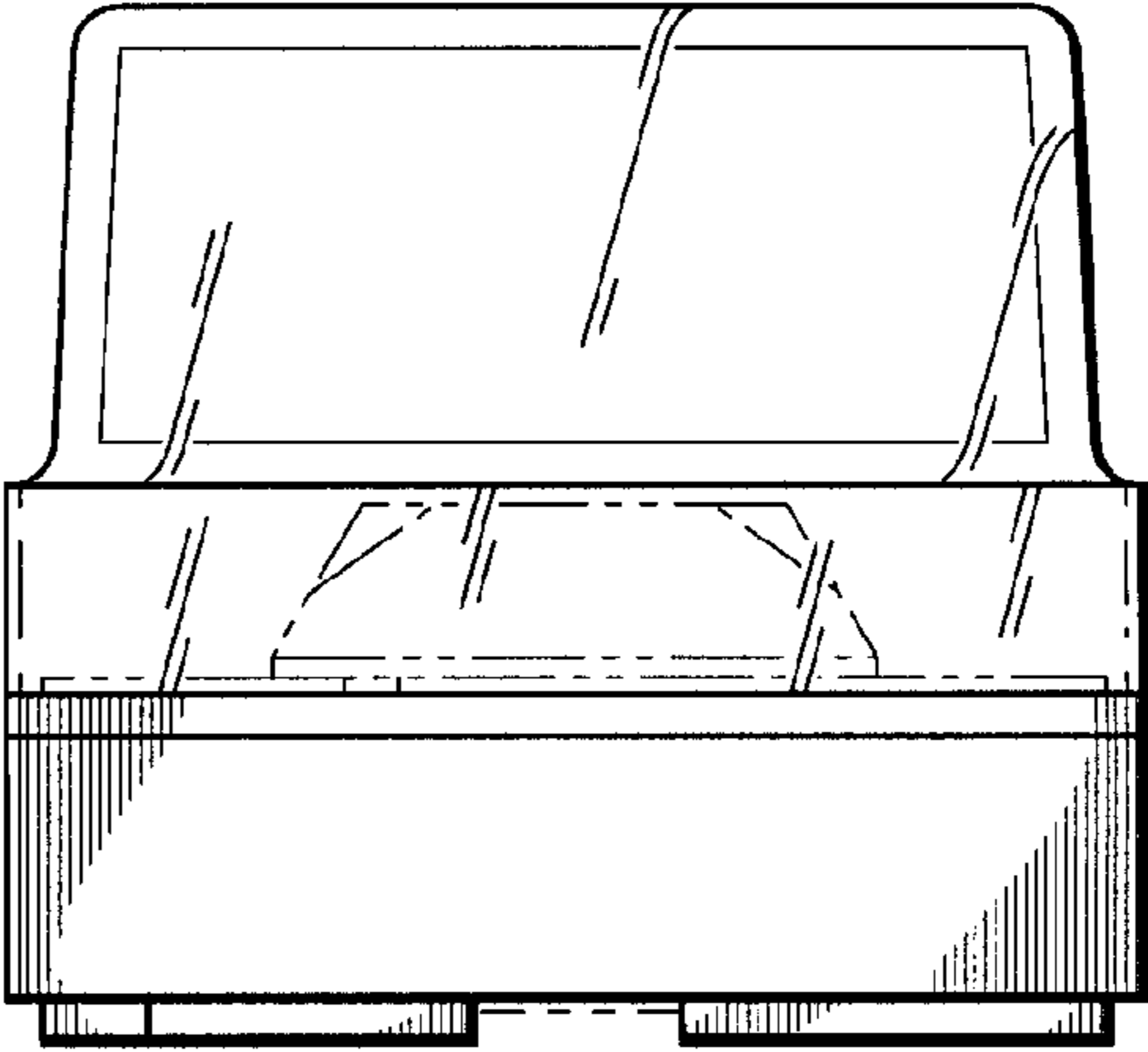


FIG. 4

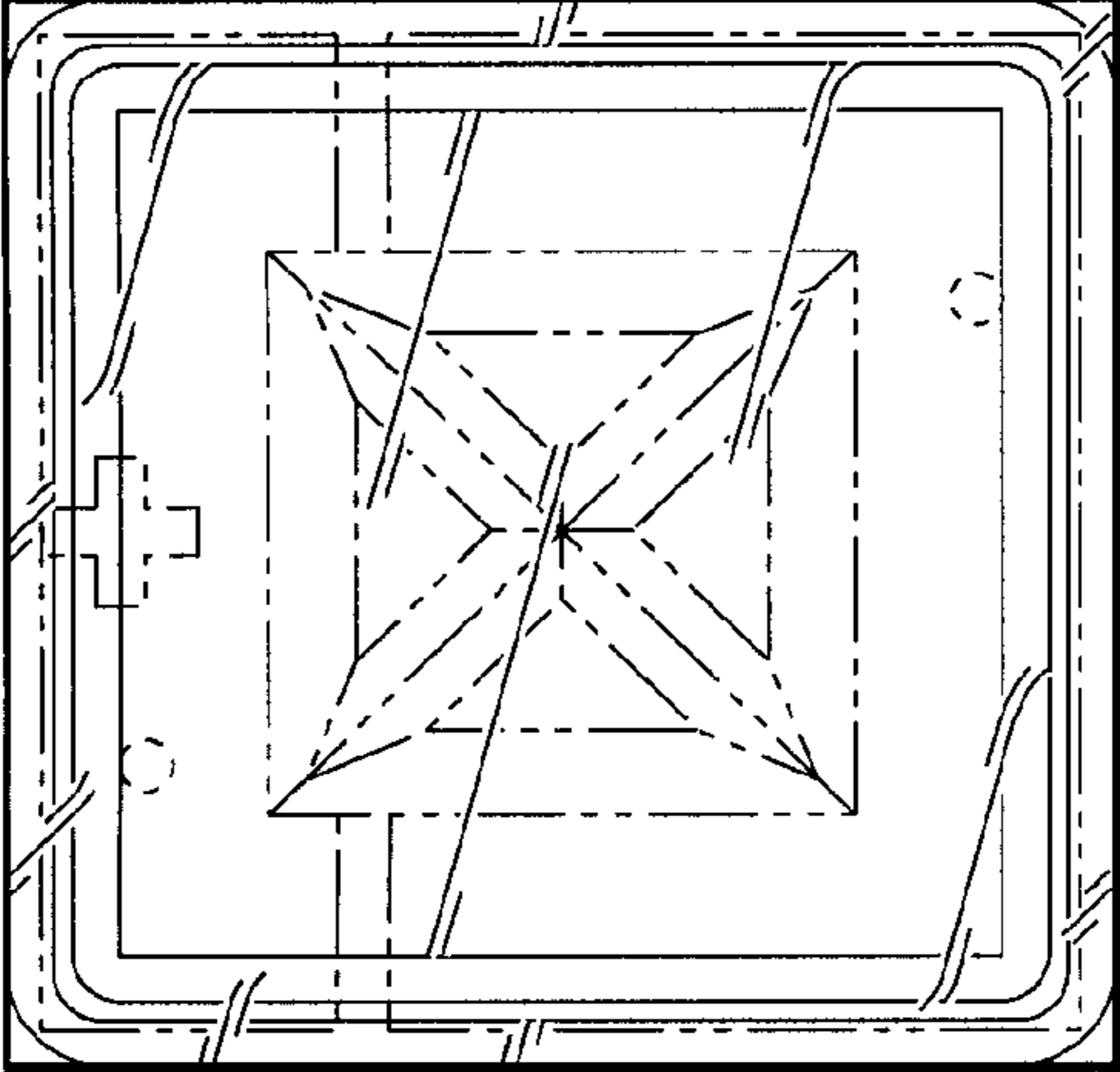


FIG. 5

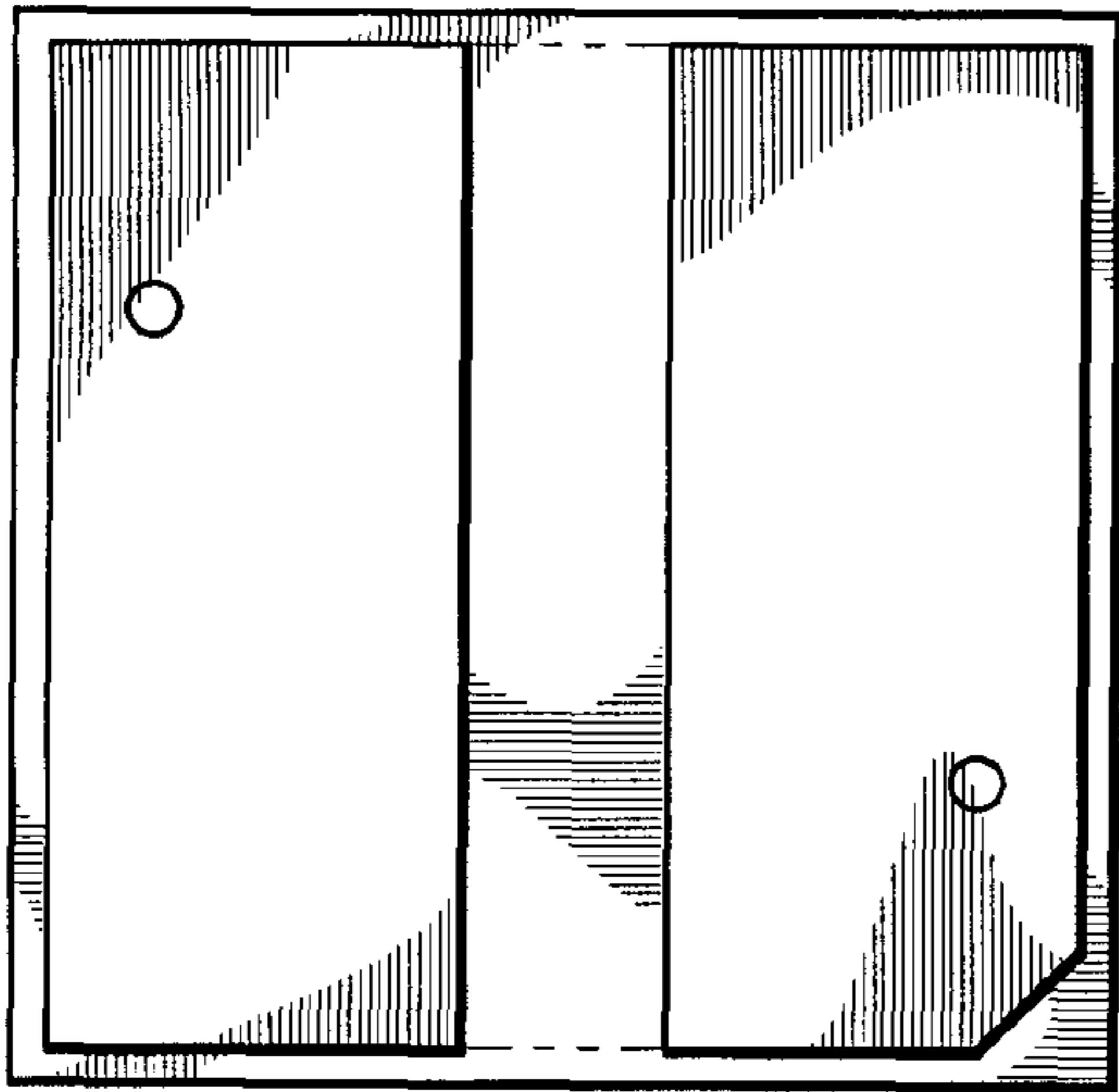


FIG. 6

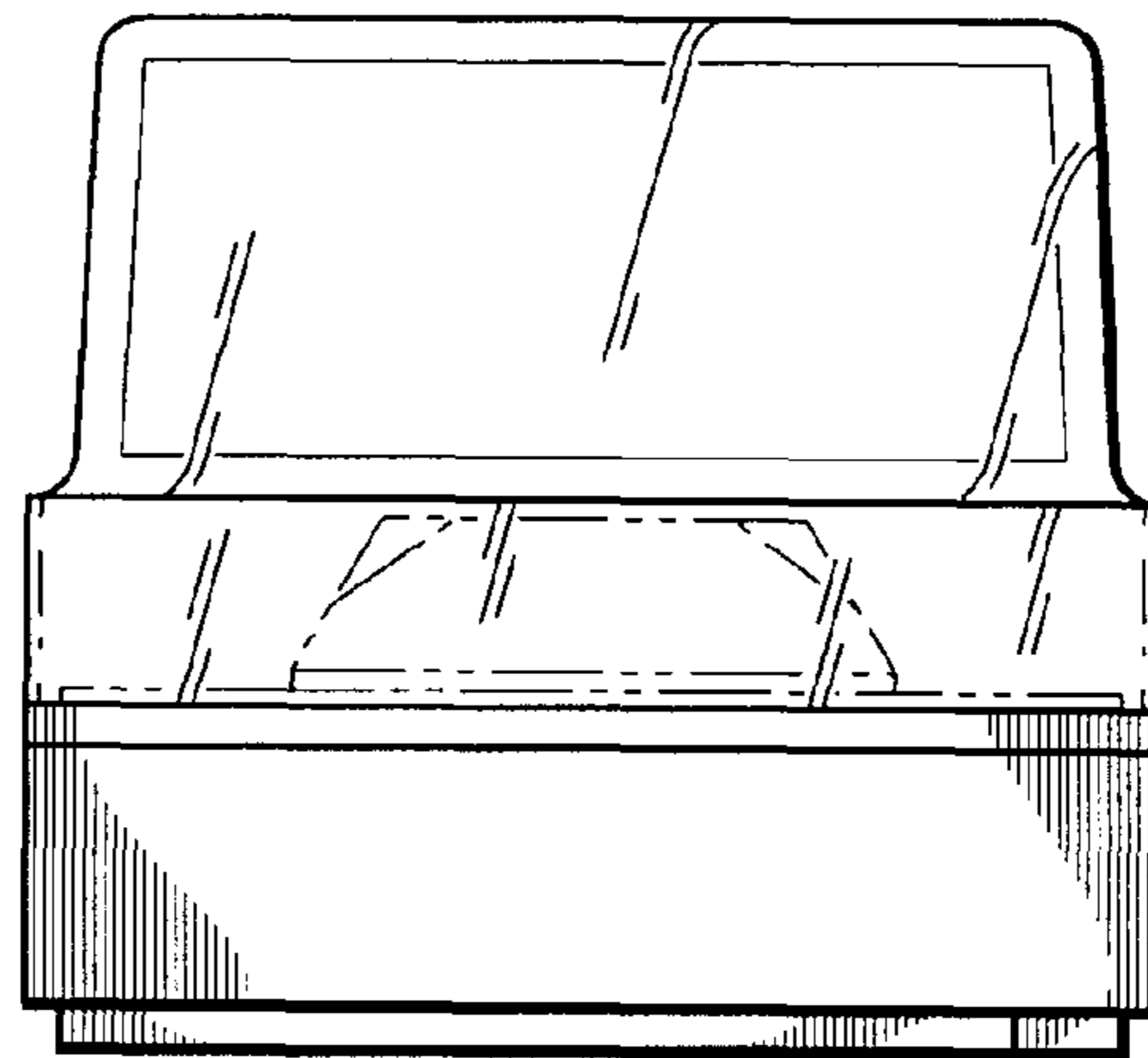


FIG. 7

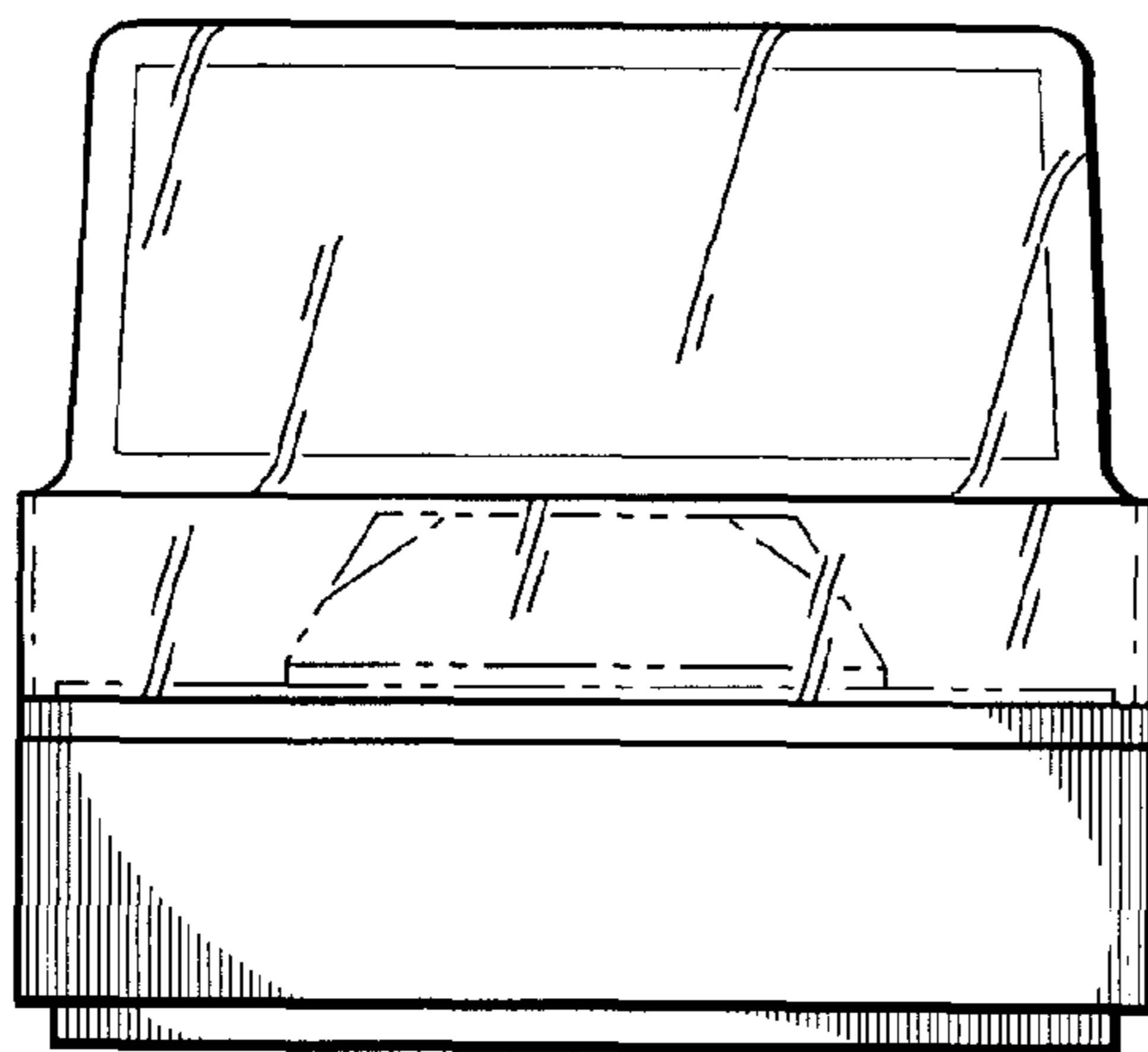


FIG. 8